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Kind regards,

Team Nexperia



Product data sheet

1. Product profile

1.1 General description

Three-terminal shunt regulator family with an output voltage range between V_{ref} and 36 V, to be set by two external resistors.

- The TL431xDBZR types feature an enhanced stability area with a very low load capacity requirement.
- The TL431xFDT types offer an enhanced stability area and a higher ElectroMagnetic Interference (EMI) ruggedness, for example, for Switch Mode Power Supply (SMPS) applications.
- The TL431xSDT types are designed for standard requirements and linear applications.

Table 1. Product overview

Reference	Temperature ran	ge (T _{amb})		Pinning
voltage tolerance (V _{ref})	0 °C to 70 °C -40 °C to 85 °C		–40 °C to 125 °C	configuration (see <u>Table 3</u>)
2 %	TL431CDBZR	TL431IDBZR	TL431QDBZR	normal pinning
			TL431FDT	normal pinning
			TL431MFDT	mirrored pinning
			TL431SDT	normal pinning
			TL431MSDT	mirrored pinning
1 %	TL431ACDBZR	R TL431AIDBZR	TL431AQDBZR	normal pinning
			TL431AFDT	normal pinning
			TL431AMFDT	mirrored pinning
			TL431ASDT	normal pinning
			TL431AMSDT	mirrored pinning
0.5 %	TL431BCDBZR	TL431BIDBZR	TL431BQDBZR	normal pinning
			TL431BFDT	normal pinning
			TL431BMFDT	mirrored pinning
			TL431BSDT	normal pinning
			TL431BMSDT	mirrored pinning



1.2 Features and benefits

Programmable output voltage up to 36 V

■ Three different reference voltage tolerances:

◆ Standard grade: 2 %

◆ A-Grade: 1 %◆ B-Grade: 0.5 %

■ Typical temperature drift: 6 mV (in a range of 0 °C up to 70 °C)

Low output noise

Typical output impedance: 0.2 Ω

Sink current capability: 1 mA to 100 mA

■ AEC-Q100 qualified (grade 1)

1.3 Applications

- Shunt regulator
- Precision current limiter
- Precision constant current sink
- Isolated feedback loop for Switch Mode Power Supply (SMPS)

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{KA}	cathode-anode voltage		V_{ref}	-	36	V
I _K	cathode current		1	-	100	mA
V _{ref}	reference voltage	$V_{KA} = V_{ref};$ $I_K = 10 \text{ mA};$ $T_{amb} = 25 \text{ °C}$				
	Standard-Grade (2 %)		2440	2495	2550	mV
	A-Grade (1 %)		2470	2495	2520	mV
	B-Grade (0.5 %)		2483	2495	2507	mV

2. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
Normal p	inning: All ty	pes without MFDT and MSD	T ending	
1	k	cathode		DEE
2	REF	reference	3	REF
3	а	anode	1 2	a □ k 006aab355
Mirrored	pinning: All	types with MFDT and MSDT	ending	
1	REF	reference		DEE
2	k	cathode	3	REF
3	а	anode		a □ k 006aab355

3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
TL431CDBZR	-	plastic surface-mounted package; 3 leads	SOT23
TL431IDBZR			
TL431QDBZR			
TL431FDT			
TL431MFDT			
TL431SDT			
TL431MSDT			
TL431ACDBZR			
TL431AIDBZR			
TL431AQDBZR			
TL431AFDT			
TL431AMFDT			
TL431ASDT			
TL431AMSDT			
TL431BCDBZR			
TL431BIDBZR			
TL431BQDBZR			
TL431BFDT			
TL431BMFDT			
TL431BSDT			
TL431BMSDT			

4. Marking

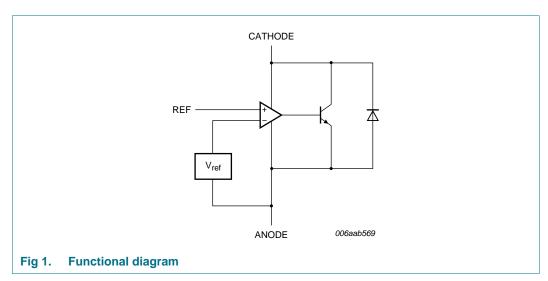
Table 5. Marking codes

Type number	Marking code ^[1]	Type number	Marking code[1]
TL431CDBZR	CA*	TL431ASDT	RL*
TL431IDBZR	CB*	TL431AMSDT	LQ*
TL431QDBZR	CC*	TL431BCDBZR	CG*
TL431FDT	AR*	TL431BIDBZR	CH*
TL431MFDT	AU*	TL431BQDBZR	CJ*
TL431SDT	RM*	TL431BFDT	AT*
TL431MSDT	LR*	TL431BMFDT	AW*
TL431ACDBZR	CD*	TL431BSDT	MA*
TL431AIDBZR	CE*	TL431BMSDT	MB*
TL431AQDBZR	CF*	-	-
TL431AFDT	AS*	-	-
TL431AMFDT	AV*	-	-

^{[1] * =} placeholder for manufacturing site code.

5. Functional diagram

The TL431 family comprises a range of 3-terminal adjustable shunt regulators, with specified thermal stability over applicable automotive and commercial temperature ranges. The output voltage may be set to any value between V_{ref} (approximately 2.5 V) and 36 V with two external resistors (see Figure 8). These devices have a typical output impedance of 0.2 Ω . Active output circuitry provides a very sharp turn-on characteristic, making these devices excellent replacements for Zener diodes in many applications like on-board regulation, adjustable power supplies and switching power supplies.



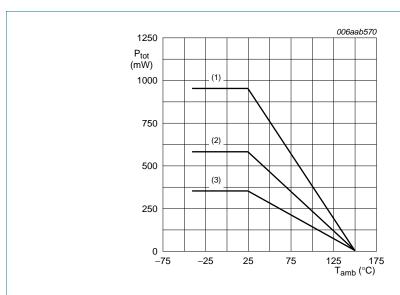
6. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{KA}	cathode-anode voltage			-	37	V
I _K	cathode current			-100	150	mA
I _{ref}	reference current			-0.05	10	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	<u>[1]</u>	-	350	mW
			[2]	-	580	mW
			[3]	-	950	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature					
	TL431XCDBZR			0	+70	°C
	TL431XIDBZR			-40	+85	°C
	TL431XQDBZR TL431XFDT TL431XSDT			-40	+125	°C
T _{stg}	storage temperature			-65	+150	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode 1 cm².
- [3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



- (1) Ceramic PCB, Al₂O₃, standard footprint
- (2) FR4 PCB, mounting pad for anode 1 cm²
- (3) FR4 PCB, standard footprint

Fig 2. Power derating curves

Table 7. ESD maximum ratings

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V _{ESD}	electrostatic discharge voltage	MIL-STD-883 (human body model)	-	4	kV

7. Recommended operating conditions

Table 8. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{KA}	cathode-anode voltage		V_{ref}	36	V
I _K	cathode current		1	100	mA

8. Thermal characteristics

Table 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1]	-	-	360	K/W
	junction to ambient		[2]	-	-	216	K/W
		[3]	-	-	132	K/W	
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]	-	-	50	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode 1 cm².
- [3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [4] Soldering point of anode.

9. Characteristics

Table 10. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		BZR; TL431FDT; TL431MFDT; 1	L431SDT; TI	L431MSDT		
V _{ref}	reference voltage	$V_{KA} = V_{ref}$; $I_K = 10 \text{ mA}$	2440	2495	2550	mV
ΔV_{ref}	reference voltage variation	$V_{KA} = V_{ref}$; $I_K = 10 \text{ mA}$				
	TL431CDBZR	T _{amb} = 0 °C to 70 °C	-	6	16	mV
	TL431IDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$	-	14	34	mV
	TL431QDBZR TL431FDT TL431MFDT TL431SDT TL431MSDT	$T_{amb} = -40 ^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$				
$\Delta V_{ref}/\Delta V_{KA}$	reference voltage reference voltage variation TL431CDBZR TL431IDBZR TL431IDBZR TL431IDBZR TL431SDT TL431MFDT TL431MSDT TL431MSDT reference voltage variation to cathode-anode voltage variation ratio reference current reference current variation TL431CDBZR TL431IDBZR TL431IDBZR TL431FDT TL431MFDT TL431MFDT TL431MFDT TL431MFDT TL431MFDT TL431MSDT minimum cathode current off-state current dynamic cathode-anode impedance (1 %): DBZR; TL431AIDBZR; TL431AIDBZR TL431ACDBZR TL431AIDBZR TL431AIDBZR TL431AIDBZR TL431AIDBZR TL431AIDBZR	I _K = 10 mA				
	to cathode-anode voltage	$\Delta V_{KA} = 10 \text{ V to } V_{ref}$	-	-1.4	-2.7	mV/V
	variation ratio	$\Delta V_{KA} = 36 \text{ V to } 10 \text{ V}$	-	-1	-2	mV/V
I _{ref}	reference current	$I_K = 10 \text{ mA};$ R1 = 10 k Ω ; R2 = open	-	2	4	μΑ
ΔI_{ref}	reference current variation	I_K = 10 mA; R1 = 10 kΩ; R2 = open				
	TL431CDBZR	T _{amb} = 0 °C to 70 °C	-	0.4	1.2	μΑ
	TL431IDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$	-	0.8	2.5	μΑ
	TL431FDT TL431MFDT TL431SDT	T _{amb} = -40 °C to 125 °C				
I _{K(min)}	minimum cathode current	$V_{KA} = V_{ref}$	-	0.4	1	mA
I _{off}	off-state current	V _{KA} = 36 V; V _{ref} = 0	-	0.1	1	μΑ
Z _{KA}		I _K = 1 mA to 100 mA; V _{KA} = V _{ref} ; f < 1 kHz	-	0.2	0.5	Ω
A-Grade (1 TL431ACD		AQDBZR; TL431AFDT; TL431A	MFDT; TL431	IASDT; TL43	B1AMSDT	
V _{ref}	reference voltage	$V_{KA} = V_{ref}$; $I_K = 10 \text{ mA}$	2470	2495	2520	mV
ΔV_{ref}	reference voltage variation	$V_{KA} = V_{ref}$; $I_K = 10 \text{ mA}$				
	TL431ACDBZR	T _{amb} = 0 °C to 70 °C	-	6	16	mV
	TL431AIDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$	-	14	34	mV
	TL431AQDBZR TL431AFDT TL431AMFDT TL431ASDT TL431AMSDT	$T_{amb} = -40 ^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$				
$\Delta V_{ref}/\Delta V_{KA}$	reference voltage variation	I _K = 10 mA				
	to cathode-anode voltage variation ratio	ΔV_{KA} = 10 V to V_{ref}	-	-1.4	-2.7	mV/V
	vanauon rauo	$\Delta V_{KA} = 36 \text{ V to } 10 \text{ V}$	-	-1	-2	mV/V

 Table 10.
 Characteristics ...continued

 $T_{amb} = 25$ °C unless otherwise specified.

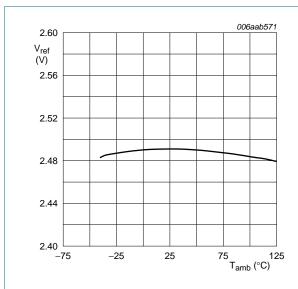
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{ref}	reference current	I_K = 10 mA; R1 = 10 kΩ; R2 = open	-	2	4	μΑ
ΔI_{ref}	reference current variation	$I_K = 10 \text{ mA};$ R1 = 10 kΩ; R2 = open				
	TL431ACDBZR	T _{amb} = 0 °C to 70 °C	-	0.4	1.2	μΑ
	TL431AIDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$	-	0.8	2.5	μΑ
	TL431AQDBZR TL431AFDT TL431AMFDT TL431ASDT TL431AMSDT	T _{amb} = -40 °C to 125 °C				
I _{K(min)}	minimum cathode current	$V_{KA} = V_{ref}$				
	TL431ACDBZR	T _{amb} = 0 °C to 70 °C	-	0.4	0.6	mA
	TL431AIDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$				
	TL431AQDBZR TL431AFDT TL431AMFDT TL431ASDT TL431AMSDT	T _{amb} = -40 °C to 125 °C				
l _{off}	off-state current	$V_{KA} = 36 \text{ V}; V_{ref} = 0$	-	0.1	0.5	μΑ
Z _{KA}	dynamic cathode-anode impedance	$I_K = 1$ mA to 100 mA; $V_{KA} = V_{ref}$; f < 1 kHz	-	0.2	0.5	Ω

V_{ref}	reference voltage	$V_{KA} = V_{ref}$; $I_K = 10 \text{ mA}$	2483	2495	2507	mV
ΔV_{ref}	reference voltage variation	$V_{KA} = V_{ref}$; $I_K = 10 \text{ mA}$				
	TL431BCDBZR	T _{amb} = 0 °C to 70 °C	-	6	16	mV
	TL431BIDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$	-	14	34	mV
TL431BQDBZR TL431BFDT TL431BMFDT TL431BSDT TL431BMSDT	TL431BFDT TL431BMFDT TL431BSDT	T _{amb} = -40 °C to 125 °C				
$\Delta V_{ref}/\Delta V_{KA}$	reference voltage variation	I _K = 10 mA				
	to cathode-anode voltage variation ratio	ΔV_{KA} = 10 V to V_{ref}	-	-1.4	-2.7	mV/V
	Variation ratio	ΔV_{KA} = 36 V to 10 V	-	-1	-2	mV/V
I _{ref}	reference current	I_K = 10 mA; R1 = 10 kΩ; R2 = open	-	2	4	μΑ

 Table 10.
 Characteristics ...continued

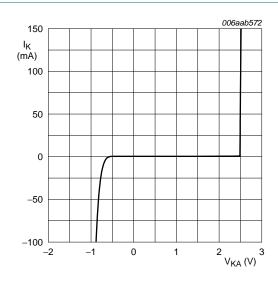
 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
ΔI_{ref}	reference current variation	$I_K = 10 \text{ mA};$ R1 = 10 kΩ; R2 = open				
	TL431BCDBZR	T _{amb} = 0 °C to 70 °C	-	0.4	1.2	μΑ
	TL431BIDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$	-	0.8	2.5	μΑ
	TL431BQDBZR TL431BFDT TL431BMFDT TL431BSDT TL431BMSDT	T _{amb} = -40 °C to 125 °C				
I _{K(min)}	minimum cathode current	$V_{KA} = V_{ref}$				
	TL431BCDBZR	T _{amb} = 0 °C to 70 °C	-	0.4	0.6	mA
	TL431BIDBZR	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$				
	TL431BQDBZR TL431BFDT TL431BMFDT TL431BSDT TL431BMSDT	$T_{amb} = -40 ^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$				
l _{off}	off-state current	$V_{KA} = 36 \text{ V}; V_{ref} = 0$	-	0.1	0.5	μΑ
Z _{KA}	dynamic cathode-anode impedance	$I_K = 1$ mA to 100 mA; $V_{KA} = V_{ref}$; f < 1 kHz	-	0.2	0.5	Ω



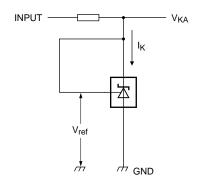
 $I_K = 10 \text{ mA}; V_{KA} = V_{ref}$

Fig 3. Reference voltage as a function of ambient temperature; typical values



 $V_{KA} = V_{ref}$; $T_{amb} = 25 \, ^{\circ}C$

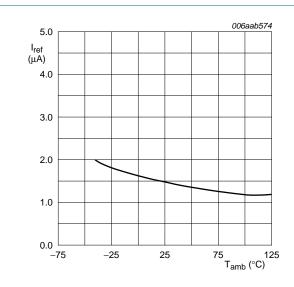
Fig 4. Cathode current as a function of cathode-anode voltage; typical values



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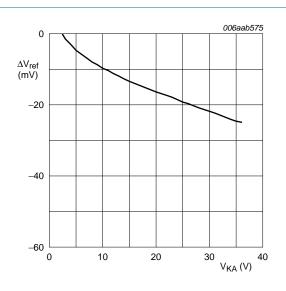
 $I_K = 10 \text{ mA}; V_{KA} = V_{ref}$

Fig 5. Test circuit to Figure 3 and Figure 4



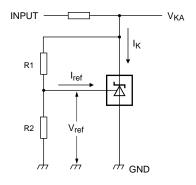
 I_K = 10 mA; R1 = 10 k Ω ; R2 = open

Fig 6. Reference current as a function of ambient temperature; typical values



 I_K = 10 mA; T_{amb} = 25 °C

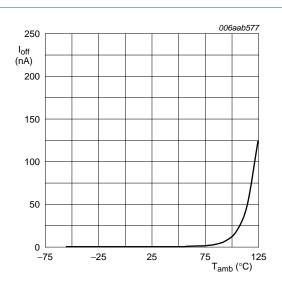
Fig 7. Reference voltage variation as a function of cathode-anode voltage; typical values



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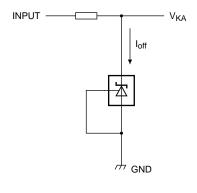
$$V_{KA} = V_{ref} \times \left(1 + \frac{RI}{R2}\right) + I_{ref} \times RI$$

Fig 8. Test circuit to Figure 6 and Figure 7



 $V_{KA} = 36 \text{ V}; V_{ref} = 0 \text{ V}$

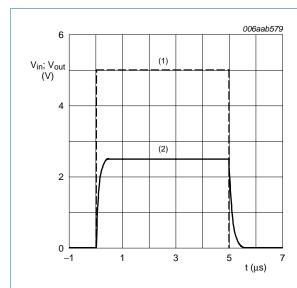
Fig 9. Off-state current as a function of ambient temperature; typical values



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 $V_{KA} = 36 \text{ V}; V_{ref} = 0 \text{ V}$

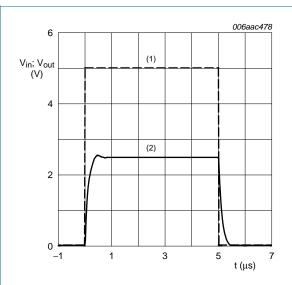
Fig 10. Off-state current as a function of ambient temperature; test circuit



T_{amb} = 25 °C

- (1) Input
- (2) Output

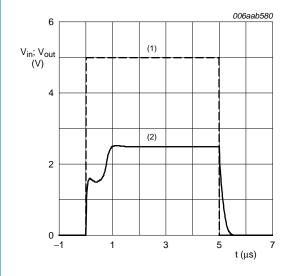
Fig 11. All types except TL431XFDT and TL431XSDT: Input voltage and output voltage as a function of time; typical values



T_{amb} = 25 °C

- (1) Input
- (2) Output

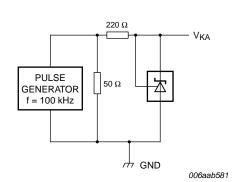
Fig 12. TL431XFDT: Input voltage and output voltage as a function of time; typical values



T_{amb} = 25 °C

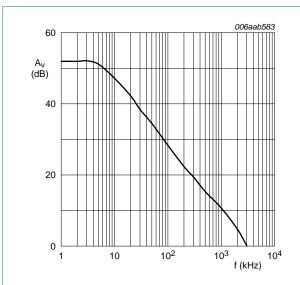
- (1) Input
- (2) Output

Fig 13. TL431XSDT: Input voltage and output voltage as a function of time; typical values



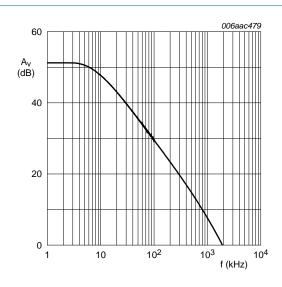
 $T_{amb} = 25 \, ^{\circ}C$

Fig 14. Test circuit to Figure 11, Figure 12 and Figure 13



 $I_K = 10 \text{ mA}$; $T_{amb} = 25 \text{ °C}$

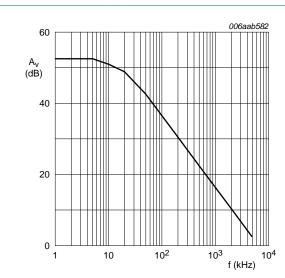
Fig 15. All types except TL431XFDT and TL431XSDT:
Voltage amplification as a function of
frequency; typical values



 I_K = 10 mA; T_{amb} = 25 °C

Fig 16. TL431XFDT:

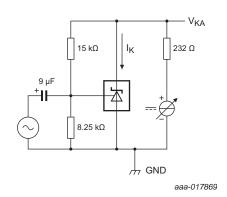
Voltage amplification as a function of frequency; typical values



 $I_K = 10 \text{ mA}; T_{amb} = 25 \, ^{\circ}\text{C}$

Fig 17. TL431XSDT:

Voltage amplification as a function of frequency; typical values



 I_K = 10 mA; T_{amb} = 25 °C

Fig 18. Test circuit to <u>Figure 15</u>, <u>Figure 16</u> and <u>Figure 17</u>

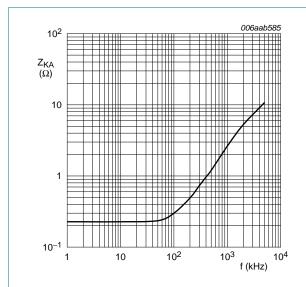
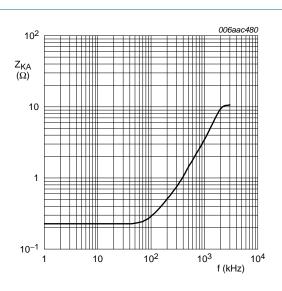


Fig 19. All types except TL431XFDT and TL431XSDT:

Dynamic cathode-anode impedance as a function of frequency; typical values

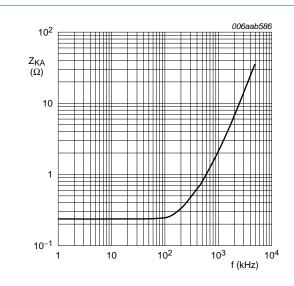
 $I_K = 10 \text{ mA}; T_{amb} = 25 \, ^{\circ}\text{C}$



 $I_K = 10 \text{ mA}$; $T_{amb} = 25 \, ^{\circ}\text{C}$

Fig 20. TL431XFDT:

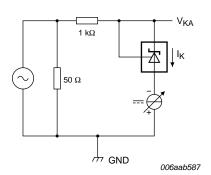
Dynamic cathode-anode impedance as a function of frequency; typical values



 $I_K = 10 \text{ mA}; T_{amb} = 25 \,^{\circ}\text{C}$

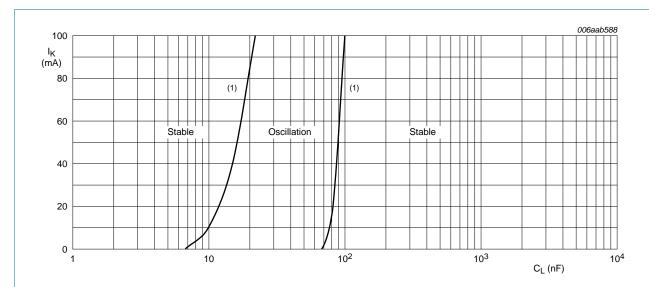
Fig 21. TL431XSDT:

Dynamic cathode-anode impedance as a function of frequency; typical values



 $I_K = 10$ mA; $T_{amb} = 25$ °C

Fig 22. Test circuit to Figure 19, Figure 20 and Figure 21



T_{amb} = 25 °C

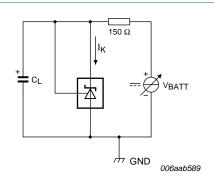
(1) $V_{KA} = V_{ref}$

V_{KA} = 5 V: no oscillation

V_{KA} = 10 V: no oscillation

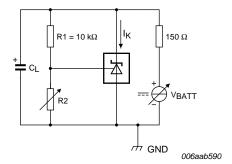
 $V_{KA} = 15 \text{ V: no oscillation}$

Fig 23. All types except TL431XFDT and TL431XSDT:
Cathode current as a function of load capacitance; typical values



 $V_{KA} = V_{ref}$ $T_{amb} = 25 \, ^{\circ}C$

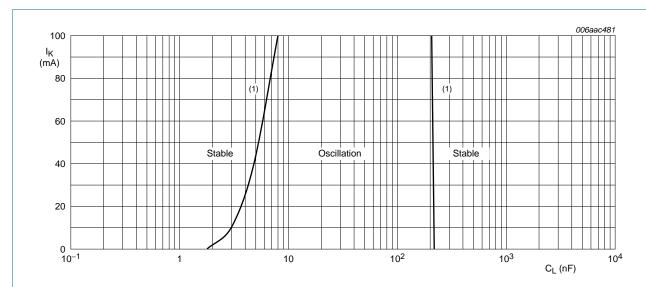
Fig 24. Test circuit (1) to Figure 23



V_{KA} > 5 V: stable operation

T_{amb} = 25 °C

Fig 25. Test circuit (2) to Figure 23



 $T_{amb} = 25 \, ^{\circ}C$

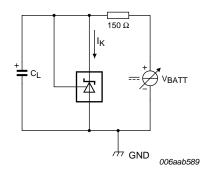
(1) $V_{KA} = V_{ref}$

 $V_{KA} = 5 \text{ V: no oscillation}$

 $V_{KA} = 10 \text{ V: no oscillation}$

 $V_{KA} = 15 \text{ V: no oscillation}$

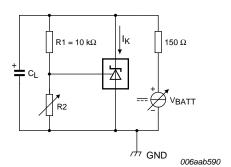
Fig 26. TL431XFDT: Cathode current as a function of load capacitance; typical values



 $V_{KA} = V_{ref}$

 $T_{amb} = 25 \, ^{\circ}C$

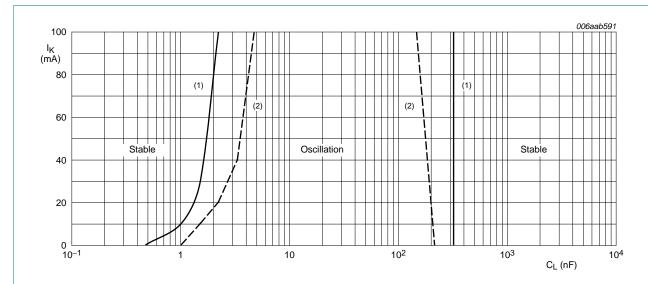
Fig 27. Test circuit (1) to Figure 26



V_{KA} > 5 V: stable operation

T_{amb} = 25 °C

Fig 28. Test circuit (2) to Figure 26



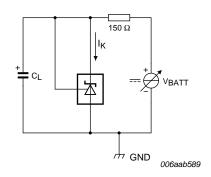
T_{amb} = 25 °C

- (1) $V_{KA} = V_{ref}$
- (2) $V_{KA} = 5 V$

V_{KA} = 10 V: no oscillation

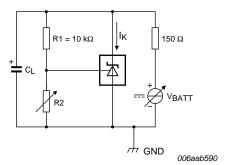
 $V_{KA} = 15 \text{ V: no oscillation}$

Fig 29. TL431XSDT: Cathode current as a function of load capacitance; typical values



 $V_{KA} = V_{ref}$ $T_{amb} = 25 \, ^{\circ}C$

Fig 30. Test circuit (1) to Figure 29



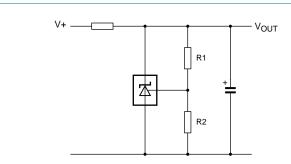
 $V_{KA} = 5 V$

V_{KA} > 10 V: stable operation

T_{amb} = 25 °C

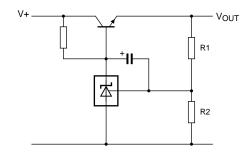
Fig 31. Test circuit (2) to Figure 29

10. Application information



$$V_{OUT} = \left(I + \frac{RI}{R2}\right) \times V_{ref}$$

Fig 32. Shunt regulator



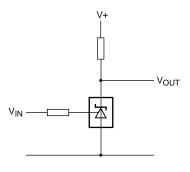
006aab593

006aab592

$$V_{OUT} = \left(1 + \frac{RI}{R2}\right) \times V_{ref}$$

$$V_{OUT(min)} = V_{ref} + V_{be}$$

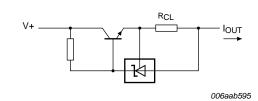
Fig 33. Series pass regulator



006aab594

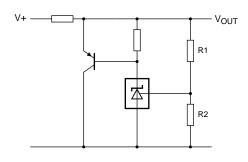
$$\begin{split} V_{th} &= V_{ref} \\ V_{IN} &< V_{ref} \Rightarrow V_{OUT} > 0 \\ V_{IN} &> V_{ref} \Rightarrow V_{OUT} \cong 2V \end{split}$$

Fig 34. Single-supply comparator with temperature-compensated threshold



$$I_{OUT} = \frac{V_{ref}}{R_{CL}}$$

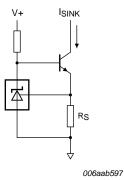
Fig 35. Constant current source



006aab596

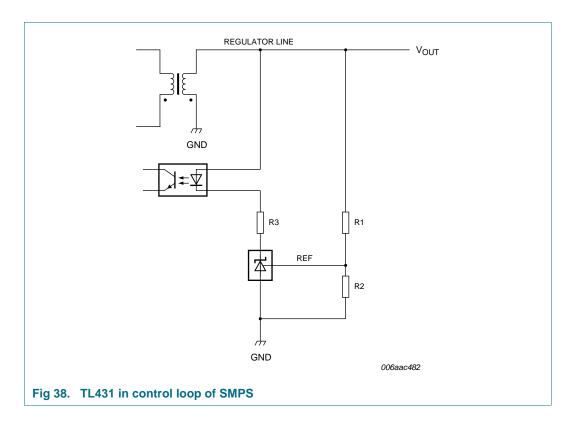
$$V_{OUT} = \left(I + \frac{RI}{R2}\right) \times V_{ref}$$

Fig 36. High-current shunt regulator



 $I_{SINK} = \frac{V_{ref}}{R_S}$

Fig 37. Constant current sink

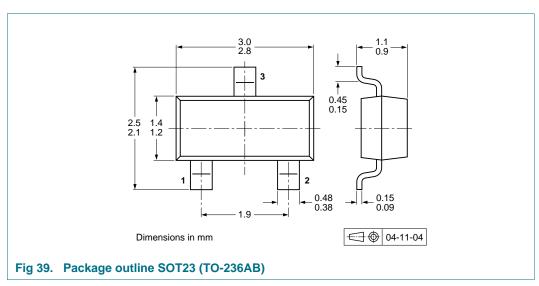


11. Test information

11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

12. Package outline

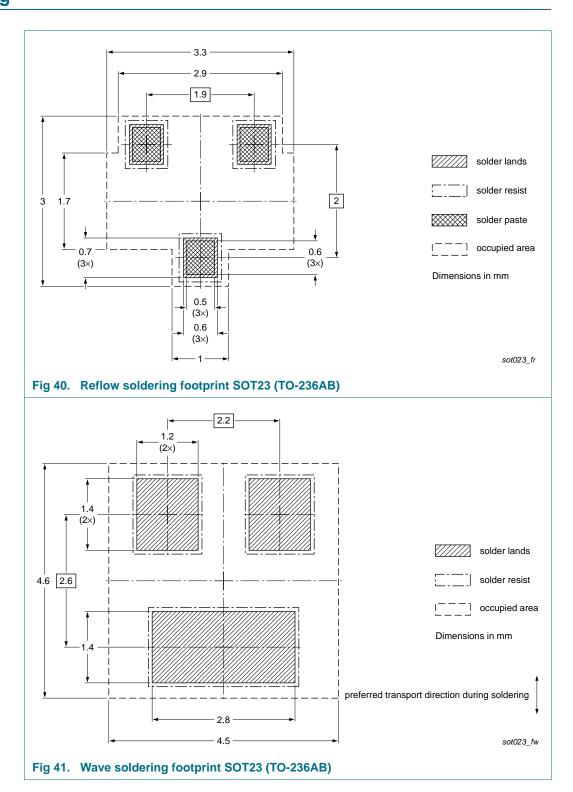


TL431 family

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13. Soldering



14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TL431_FAM v.5	20150901	Product data sheet	-	TL431_FAM v.4
Modifications:	• <u>Figure 18</u> : 0	Capacitor value corrected		
TL431_FAM v.4	20110630	Product data sheet	-	TL431_FAM v.3
TL431_FAM v.3	20101105	Product data sheet	-	TL431_FAM v.2
TL431_FAM v.2	20100120	Product data sheet	-	TL431_FAM v.1
TL431_FAM v.1	20090806	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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